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PATENT APPLICATION  
Attorney Docket No.9898-206

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Shin KIM, et al.

Serial No. 10/068,628

Examiner:

Dinh, Tuan T

Filed: February 6, 2002

Group Art Unit:

2827

For: SEMICONDUCTOR DEVICE BONDING PAD RESISTANT TO  
STRESS AND METHOD OF FABRICATING THE SAME

RECEIVED  
MAY 20 2002  
TC-2800 MAIL ROOM

TRANSMITTAL LETTER

Assistant Commissioner for Patents  
Washington, D.C. 20231

Enclosed for filing in the above-referenced application are the following:

- ☒ Response to Restriction Requirement
- ☒ Return post card



20575

PATENT TRADEMARK OFFICE

Respectfully submitted,

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ON 5-7-02